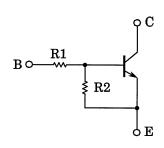
TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT Process)

## RN1101MFV,RN1102MFV,RN1103MFV RN1104MFV,RN1105MFV,RN1106MFV

Switching, Inverter Circuit, Interface Circuit and Driver Circuit Applications

- Ultra-small package, suited to very high density mounting
- Incorporating a bias resistor into the transistor reduces the number of parts, so enabling the manufacture of ever more compact equipment and lowering assembly cost.
- A wide range of resistor values is available for use in various circuits.
- Complementary to the RN2101MFV to RN2106MFV

### **Equivalent Circuit and Bias Resistor Values**



Type No.	R1 (kΩ)	R2 (kΩ)
RN1101MFV	4.7	4.7
RN1102MFV	10	10
RN1103MFV	22	22
RN1104MFV	47	47
RN1105MFV	2.2	47
RN1106MFV	4.7	47

# 1. BASE 2. EMITTER 3. COLLECTOR JEDEC JEITA TOSHIBA 1.0.05 0.80 ± 0.05 0.80 ±

Weight: 1.5 mg (typ.)

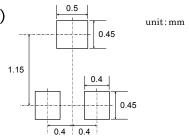
### Absolute Maximum Ratings (Ta = 25°C)

Characte	Symbol	Rating	Unit		
Collector-base voltage	RN1101MFV to 1106MFV	$V_{CBO}$	50	V	
Collector-emitter voltage	TRIVITOTIVII V TO TTOOIVII V	$V_{CEO}$	50	V	
Emitter-base voltage	RN1101MFV to 1104MFV	Vene	10	V	
Emiller-base vollage	RN1105MFV, 1106MFV	V <sub>EBO</sub>	5		
Collector current		Ic	100	mA	
Collector power dissipation	RN1101MFV to 1106MFV	P <sub>C</sub> (Note 1)	150	mW	
Junction temperature	KINTTOTIVITY TO TTOOIVITY	Tj	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board (25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm)

### Pad Dimension (Reference)

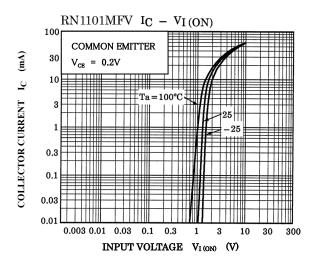


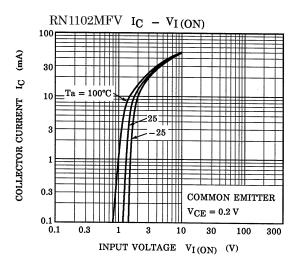


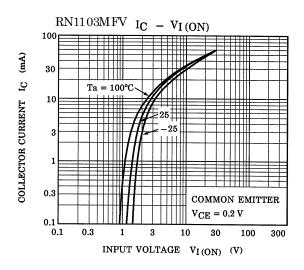
# Electrical Characteristics (Ta = 25°C)

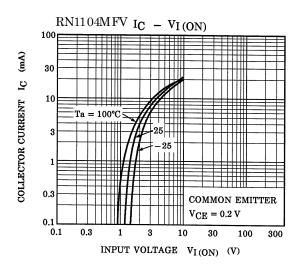
Characte	eristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Collector cutoff current	RN1101MFV to	Ісво		V <sub>CB</sub> = 50 V, I <sub>E</sub> = 0	_	_	100	nA
Collector cuton current	1106MFV	I <sub>CEO</sub>		V <sub>CE</sub> = 50 V, I <sub>B</sub> = 0	_	_	500	
Emitter cutoff current	RN1101MFV	I <sub>EBO</sub>	_	V <sub>EB</sub> = 10 V, I <sub>C</sub> = 0	0.82	_	1.52	- mA
	RN1102MFV				0.38	_	0.71	
	RN1103MFV				0.17	_	0.33	
Emiliter Cuton Current	RN1104MFV				0.082	_	0.15	
	RN1105MFV			V <sub>EB</sub> = 5 V, I <sub>C</sub> = 0	0.078	_	0.145	
	RN1106MFV				0.074	_	0.138	
	RN1101MFV				30	_	_	
	RN1102MFV				50	_	_	
DC ourrent gain	RN1103MFV	h		\\\-= = \( \) \\ \  \  \  \  \  \  \  \  \  \  \  \	70	_	_	
DC current gain	RN1104MFV	h <sub>FE</sub>	_	$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA}$	80	_	_	
	RN1105MFV				80	_	_	
	RN1106MFV				80	_	_	
Collector-emitter saturation voltage	RN1101MFV to 1106MFV	V <sub>CE</sub> (sat)	_	I <sub>C</sub> = 5 mA, I <sub>B</sub> = 0.5 mA	_	0.1	0.3	٧
	RN1101MFV	Vi (ON)		V <sub>CE</sub> = 0.2 V, I <sub>C</sub> = 5	1.1	_	2.0	. v
	RN1102MFV		_		1.2	_	2.4	
	RN1103MFV				1.3	_	3.0	
Input voltage (ON)	RN1104MFV				1.5	_	5.0	
	RN1105MFV				0.6	_	1.1	
	RN1106MFV				0.7	_	1.3	
Input voltage (OFF)	RN1101MFV to 1104MFV	V <sub>I (OFF)</sub>	_	V <sub>CE</sub> = 5 V, I <sub>C</sub> = 0.1	1.0	_	1.5	V
	RN1105MFV, 1106MFV				0.5	_	0.8	
Collector output capacitance	RN1101MFV to 1106MFV	C <sub>ob</sub>	_	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1 MH <sub>z</sub>	_	0.7	_	pF
Input resistor	RN1101MFV	R1	_	_	3.29	4.7	6.11	kΩ
	RN1102MFV				7	10	13	
	RN1103MFV				15.4	22	28.6	
	RN1104MFV				32.9	47	61.1	
	RN1105MFV				1.54	2.2	2.86	
	RN1106MFV				3.29	4.7	6.11	
Resistor ratio	RN1101MFV to 1104MFV	R1/R2	_	_	0.8	1.0	1.2	
	RN1105MFV				0.0376	0.0468	0.0562	
	RN1106MFV				0.08	0.1	0.12	

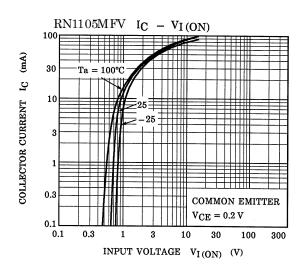
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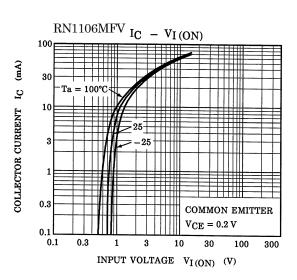


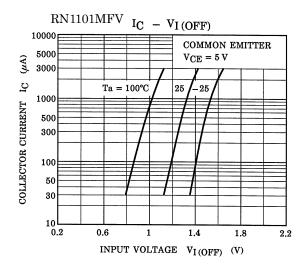


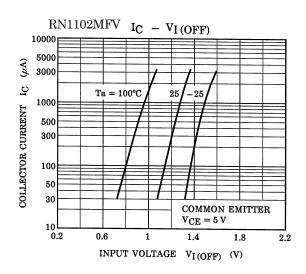


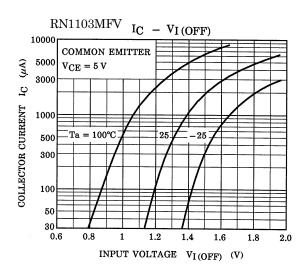


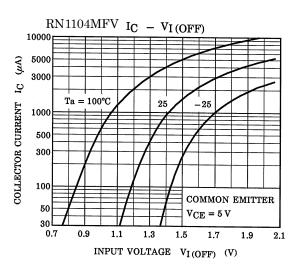


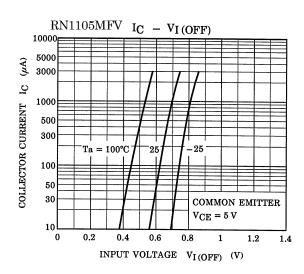


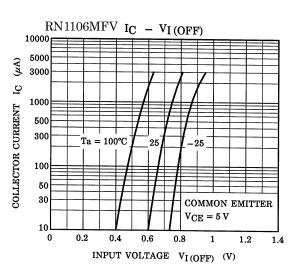


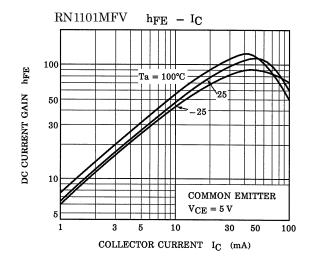


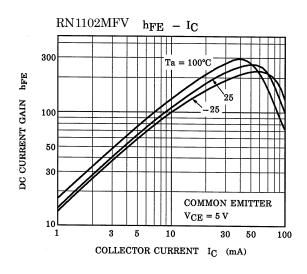


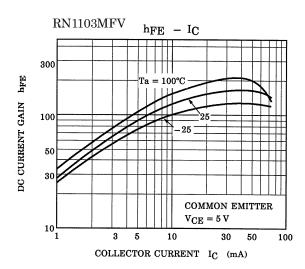


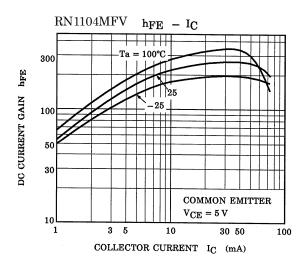


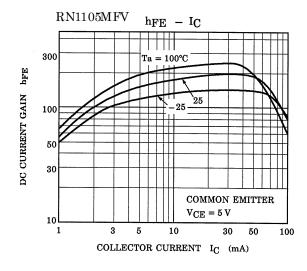


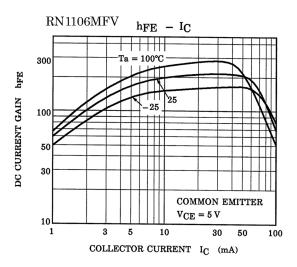


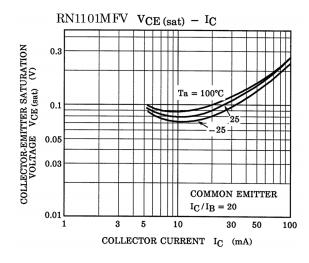


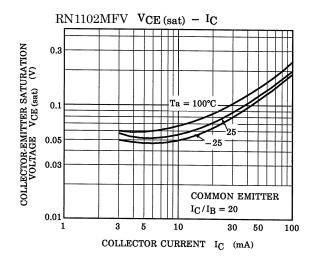


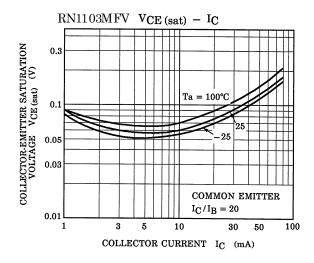


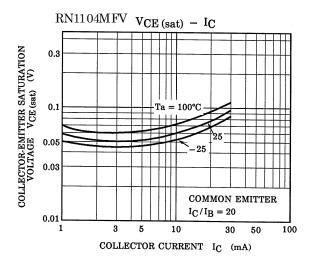


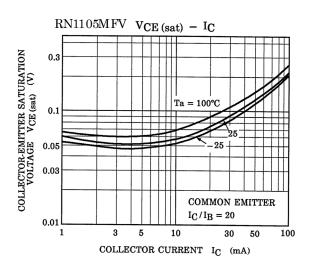


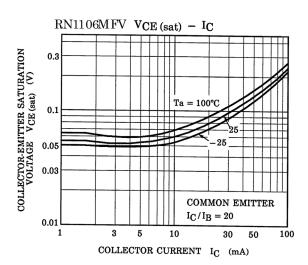












Type Name	Marking
RN1101MFV	Type Name
RN1102MFV	Type Name
RN1103MFV	Type Name
RN1104MFV	Type Name
RN1105MFV	Type Name  XE
RN1106MFV	Type Name

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